GENERAL DESCRIPTION

SE87XX series is designed for power-sensitive applications. It includes a precision and high voltage input stage, an ultra-low-power bias current branch, and results in a ultra-low-power and low-dropout linear regulator.

The SE87XX operates from an input voltage of V_{OUT}+1V to 40V, consumes only 2.6μA of quiescent current, and offers 1% initial accuracy and SoftStart function. At power startup, the output voltage overshoot is less than 100mV.

The SE87XX regulators is available in standard SOT89-3L, and SOT23-3L packages. Standard products are Pb-free and Halogen-free.

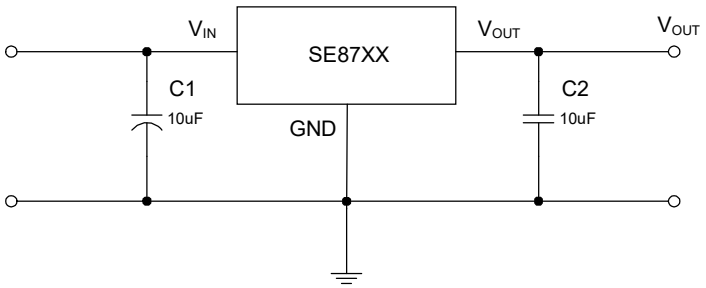
FEATURES

- Input voltage: 4.5V~40V
- Output voltage: 1.8V~5.7V
- Output accuracy: <±1%
- Output current: 100mA (Typ.)
- PSRR: 60dB @ 100Hz
- Quiescent current: 4.2μA @ VIN = 12V(Typ.)
- ESD HBM: 3KV
- Recommend capacitor: 10μF
- No overshoot from short circuit recovery
- UVLO at 1.8V

APPLICATIONS

- Battery-powered Smoke sensor
- Smoke sensor
- Microcontrollers
- Household appliances and instruments

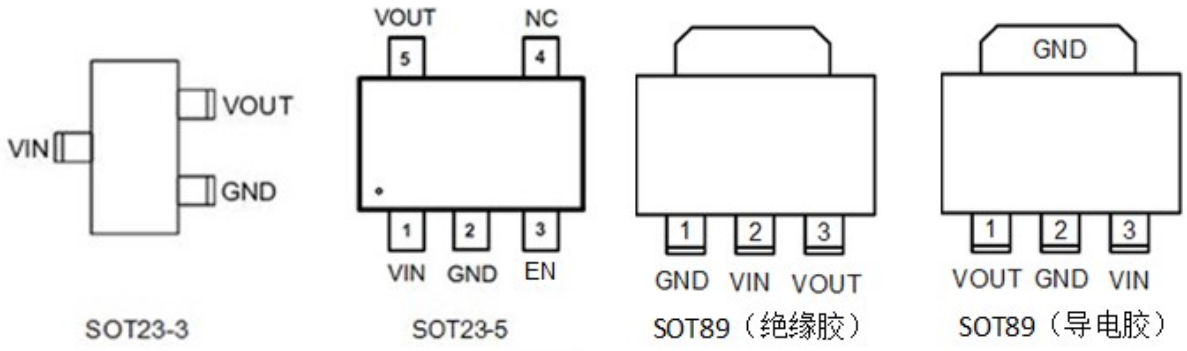
TYPICAL APPLICATION CIRCUIT



In plugging in application, C_{IN} is recommended to use 10uF electrolytic capacitor or 10uF MLCC with 2 ohm serial resistors to prevent large input voltage spike when plugging in. See APPLICATION INFORMATION for more information.

PIN CONFIGURATION

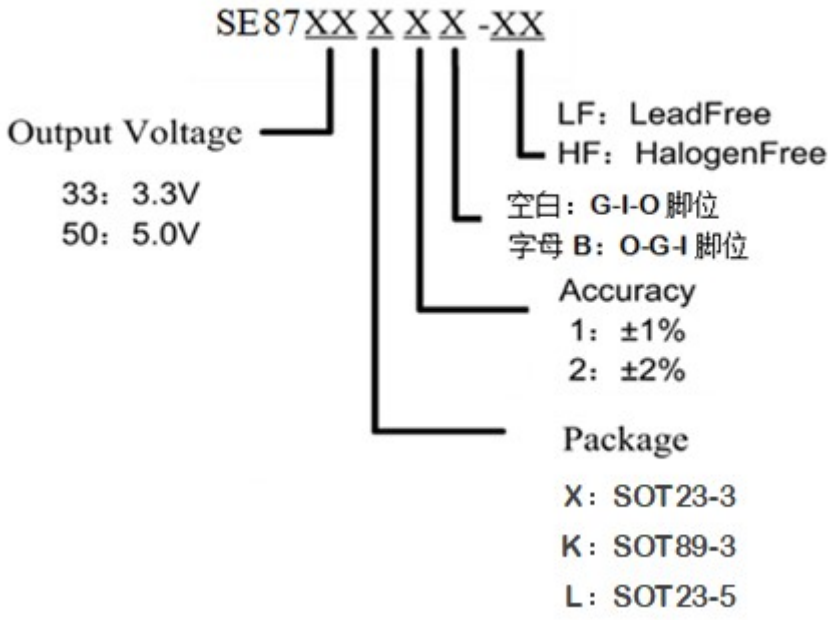
(Customer pin assignments are available)



PIN DESCRIPTION

SYMBOL	I/O	DESCRIPTTION
GND	Ground	Ground
VIN	Power	Input
VOUT	O	Output

ORDERING INFORMATION



ABSOLUTE MAXIMUM RATINGS (Note)

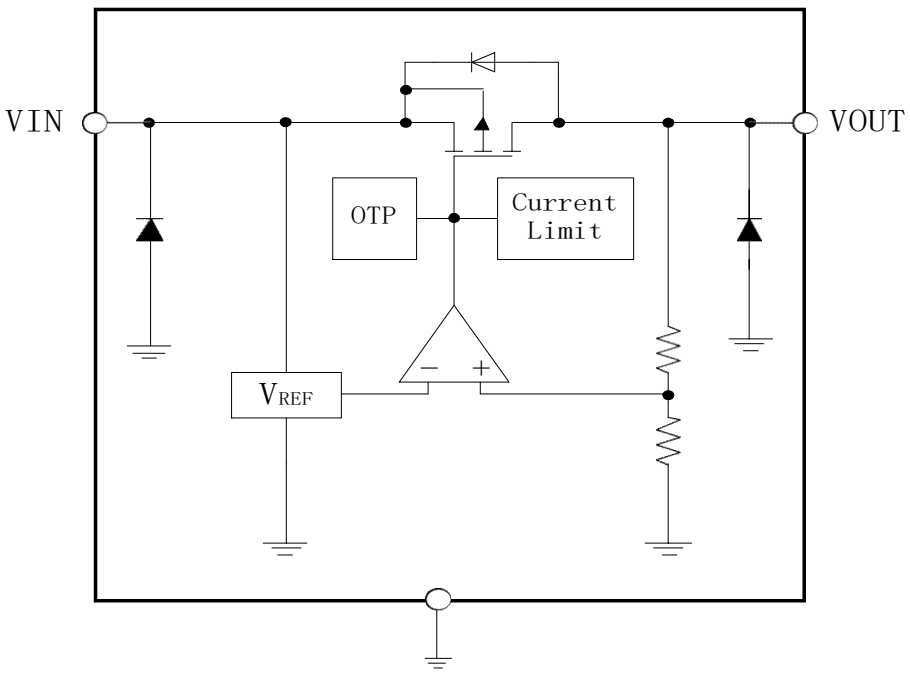
SYMBOL	ITEMS	VALUE	UNIT
V_{IN}	Input Voltage	-0.3~45	V
V_{OUT}	Output Voltage	-0.3~6.5	V
P_{DMAX}	Power Dissipation	OTP limited	W
T_J	Junction Temperature	-40~150	℃
Tstg	Storage Temperature	-55 to 150	℃
Tsolder	Package Lead Soldering Temperature (10s)	260	℃
ESD MM	Machine Mode	200	V
ESD HBM	Human Body Mode	3000	V
θ_{JA}	Thermal Resistance, Junction-to-Ambient	165（SOT89）	℃/W
		280（SOT23）	
P_D	Power Consumption	750（SOT89）	mW
		250（SOT23）	

Note: *Exceed these limits to damage to the device. Exposure to absolute maximum rating conditions may affect device reliability.*

RECOMMANDED OPERATING RANGE

SYMBOL	ITEMS	VALUE	UNIT
V_{IN}	V_{IN} Supply Voltage	4.5 to 40	V
$R_{\theta JA}$	Thermal Resistance on PCB	45	℃/W
T_{OPT}	Operating Temperature	-40 to +105	℃

SIMPLIFIED BLOCK DIAGRAM



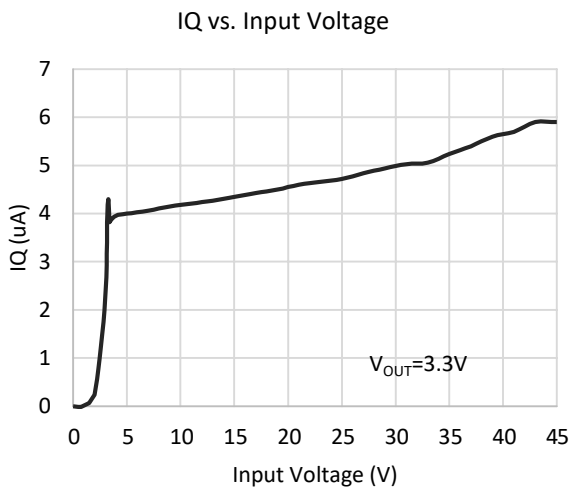
ELECTRICAL CHARACTERISTICS

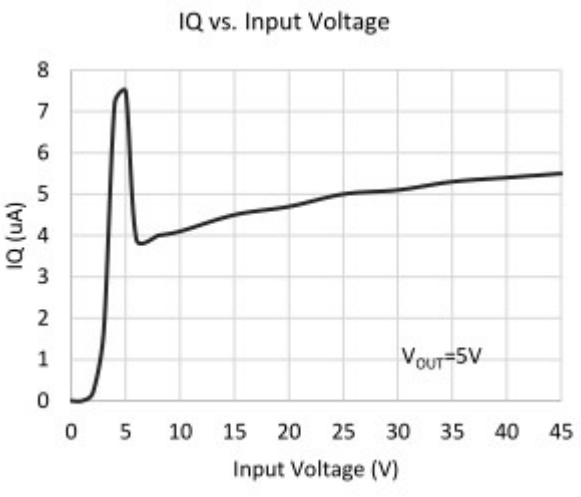
（V_{IN}=12V； Tj=25℃ unless otherwise noted.）

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IN}	Input Supply Voltage		4.5		40	V
V_{OUT}	Output Voltage Accuracy	I_{OUT}=10mA	-1%		1%	V
			-2%		2%	V
I_Q	Quiescent Current			4.5	8	μA
I_{OUT}	Output Current		150	200		mA
V_{DROP}	Dropout Voltage	I_{OUT}=10mA ΔV_{OUT}= - V_{OUT} *2%		60		mV
		I_{OUT}=100mA ΔV_{OUT}= - V_{OUT} *2%		600		mV
V_{LR}	Load Regulation	1mA ≤ I_{OUT}≤ 100mA		20		mV
V_{SR}	Line Regulation	I_{OUT}=1mA, V_{IN}=(V_{OUT} +4V) to 45V		0.08		%/V
PSRR	Power Supply Rejection Ratio (Vin=10V, V_{PP}=0.5V, Iout=1mA)	Freq=100Hz		60		dB
		Freq=1KHz		50		dB
		Freq=10KHz		40		dB
I_{LIMIT}	Current Limit	V_{IN}=(V_{OUT} +1V) to 30V R_{LOAD}=V_{OUT} /1A		350		mA
T_{SHDN}	Thermal Protection			165		℃
TC_{VOUT}	Output Voltage Temperature Coefficient	I_{OUT}=10mA -40℃≤T_{AMB}≤100℃		±100		ppm/℃

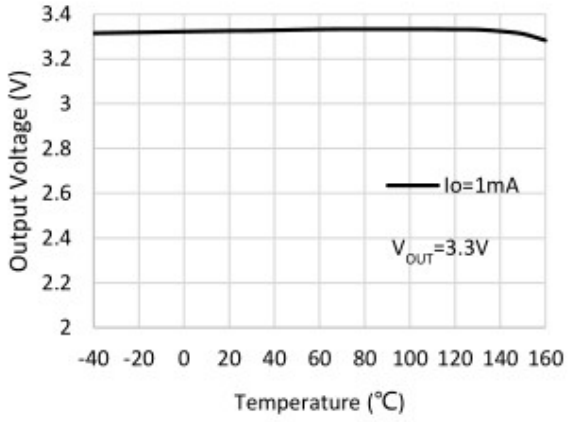
TYPICAL PERFORMANCE CHARACTERISTICS

C_{IN} = 10μF, C_{OUT} = 10μF, T_{OPT} = 25℃, unless specified otherwise. (SE87XXK2B Package)

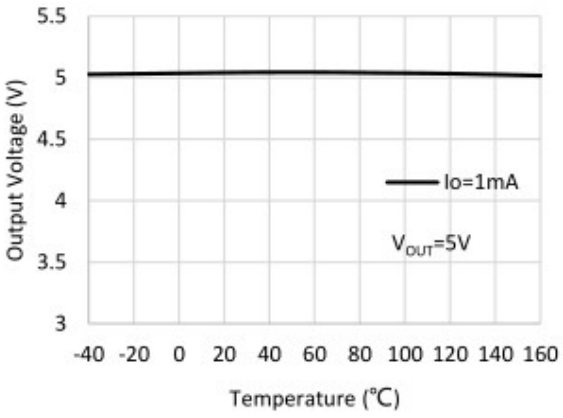




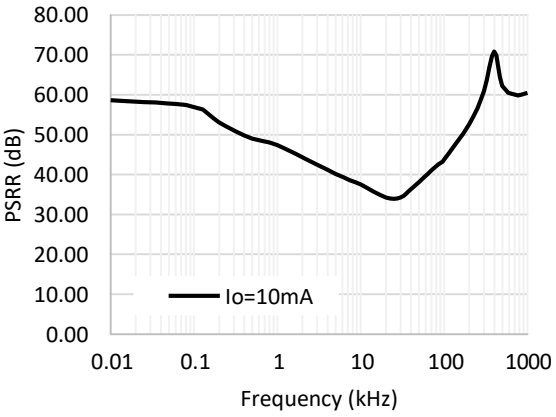
Output Voltage vs. Temperature



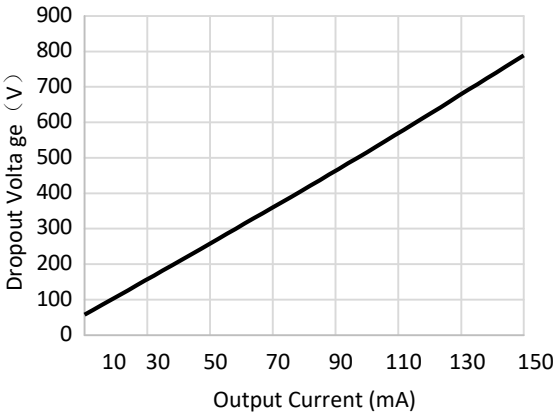
Output Voltage vs. Temperature



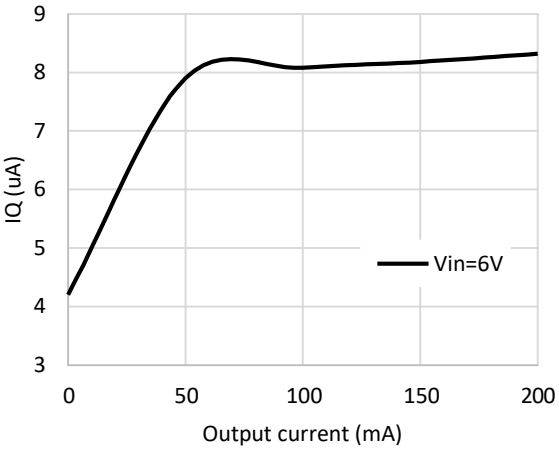
PSRR vs. Frequency



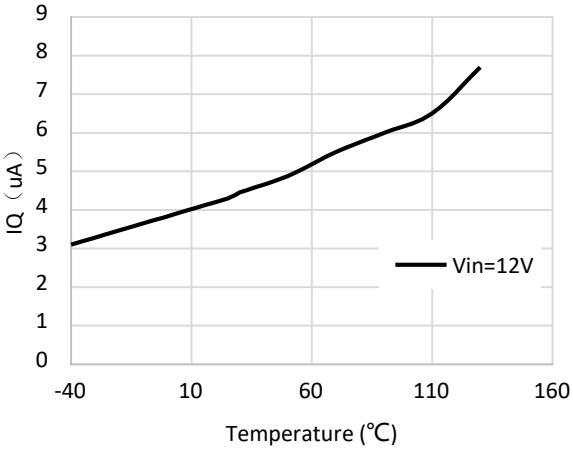
Dropout Voltage vs. Output Current

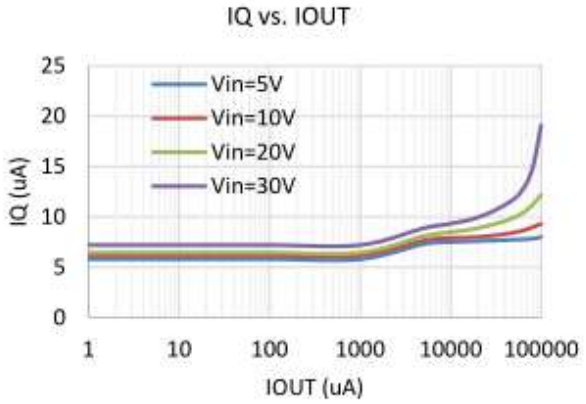


IQ vs. Output current



IQ vs. Temperature

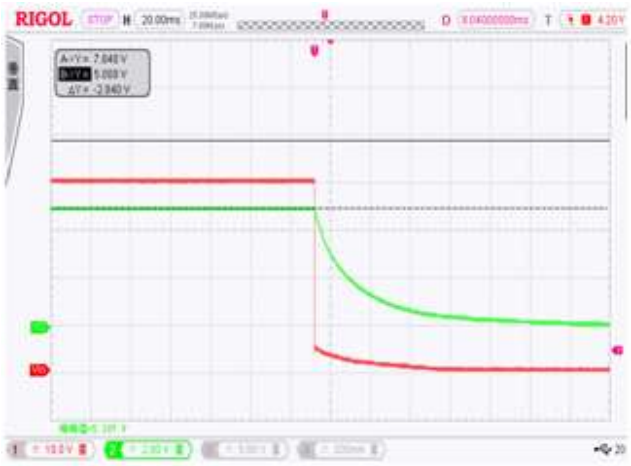




Power ON/OFF

CH1 : V_{IN} **CH2 : V_{OUT}**

V_{IN}=40V I_{OUT}=1mA V_{OUT}=5V



Line Transient

CH1: V_{IN} **CH2 : V_{OUT}**

V_{IN}=6V-12V I_{OUT}=1mA V_{OUT}=5V

V_{IN}=6V-12V I_{OUT}=10mA V_{OUT}=5V

APPLICATION INFORMATION

INPUT CAPACITOR

An input capacitor of 10µF is required between the VIN and GND pin. The capacitor shall be placed as close as possible to VIN pin, and the use of electrolytic capacitors is recommended.

OUTPUT CAPACITOR

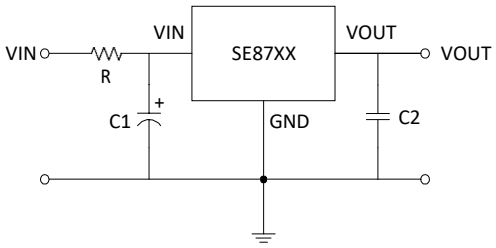
The recommended is 10uF MLCC capacitor. The minimum capacitance for stable and correct operation is 1µF.

NO-LOAD STABILITY

The SE87XX will remain stable and in regulation with no external load. This is especially important in CMOS RAM keep-alive applications.

TYPICAL CIRCUIT

The following figure shows a typical application circuit for the SE87XX devices. Please keep in mind that in-rush current can push up the Vin overshoot by as much as 50%. For example, when Vin=30V, the in-rush caused spike voltage can be as high as 45V. Therefore the voltage rating of Cin needs to be higher than 50% of the application.



In live insertion application, it is suggested that R, C1 are selected as following:

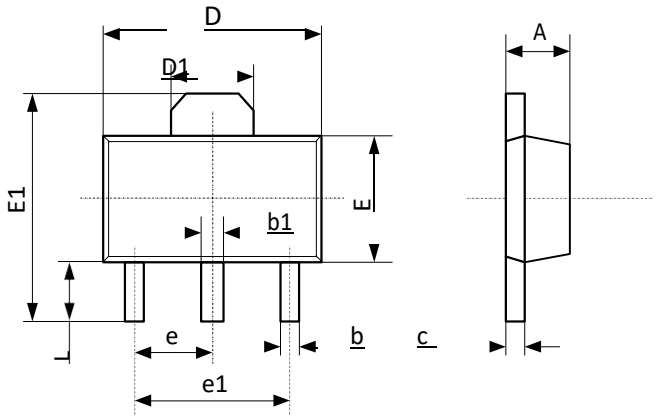
1.C1=10µF ~ 100µF electrolytic capacitor with maximum voltage greater than 50V, R=0

2.If the average current is known, for example at 10mA, then for an input voltage of 20V, the C1=1µF ~ 10µF ceramic or electrolytic with maximum voltage greater than 40V and R=1KΩ in the type of 1206 at 1/4W rating can be selected.

PACKAGE OUTLINE

Package	SOT89-3L	Devices per reel	1000Pcs	Unit	mm

Package Dimension：

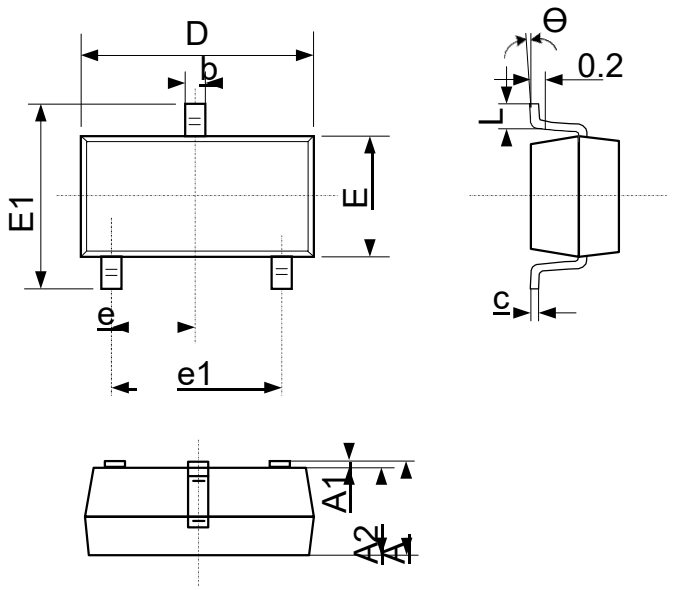


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.45	1.65	0.057	0.065
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060 TYP	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047

PACKAGE OUTLINE

Package	SOT23-3L	Devices per reel	3000Pcs	Unit	mm

Package Dimension：

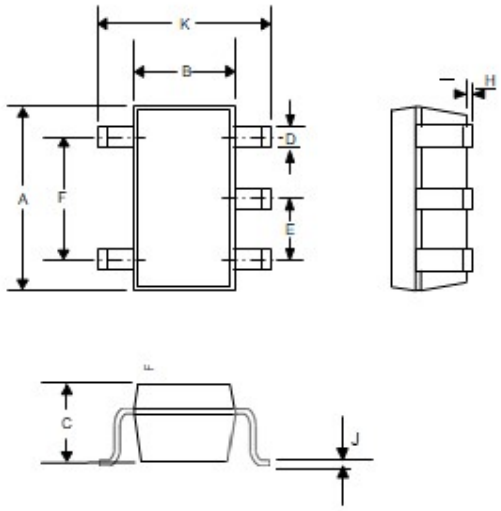


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0℃	8℃	0℃	8℃

PACKAGE OUTLINE

Package	SOT23-5L	Devices per reel	3000Pcs	Unit	mm

Package Dimension：



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.110	0.120	2.80	3.05
B	0.059	0.070	1.50	1.75
C	0.036	0.051	0.90	1.30
D	0.014	0.020	0.35	0.50
E	-	0.037	-	0.95
F	-	0.075	-	1.90
H	-	0.006	-	0.15
J	0.0035	0.008	0.090	0.20
K	0.102	0.118	2.60	3.00

Customer Support

Seaward Electronics Incorporated – China

Section B, 2nd Floor, ShangDi Scientific Office Complex, #22 XinXi Road

Haidian District, Beijing 100085, China

Tel：86-10-8289-5700/01/05

Fax：86-10-8289-5706

Email：sales@seawardinc.com.cn

Seaward Electronics Incorporated – North America

1512 Centre Pointe Dr.

Milpitas, CA95035, USA

Tel：1-650-444-0713